

50 V, 230 mA P-channel Trench MOSFET Rev. 1 — 23 May 2011

Product data sheet

1. **Product profile**

1.1 General description

P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small SOT883 (SC-101) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Logic-level compatible
- Very fast switching
- Trench MOSFET technology

1.3 Applications

- Relay driver
- High-speed line driver

- ESD protection up to 1 kV
- AEC-Q101 qualified
- High-side loadswitch
- Switching circuits

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-50	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V_{GS} = -10 V; T_{amb} = 25 °C	<u>[1]</u>	-	-	-230	mA
Static cha	racteristics						
R _{DSon}	drain-source on-state resistance	V_{GS} = -10 V; I _D = -100 mA; T _j = 25 °C		-	4.5	7.5	Ω

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².



50 V, 230 mA P-channel Trench MOSFET

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	S	source		
3	D	drain	2 Transparent top view SOT883 (SOT883)	G G Sym146

3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
BSS84AKM	SOT883	leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm	SOT883			

4. Marking

Table 4. Marking codes	
Type number	Marking code ^[1]
BSS84AKM	ZA

[1] % = placeholder for manufacturing site code

Limiting values 5.

Table 5. **Limiting values**

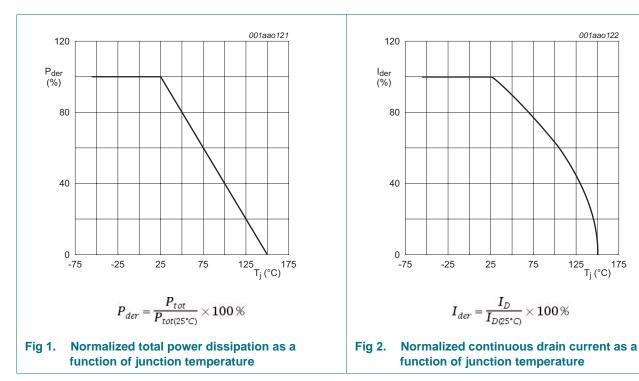
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-50	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V_{GS} = -10 V; T_{amb} = 25 °C	<u>[1]</u>	-	-230	mA
		V_{GS} = -10 V; T_{amb} = 100 °C	<u>[1]</u>	-	-150	mA
I _{DM}	peak drain current	$T_{amb} = 25 \text{ °C}$; single pulse; $t_p \le 10 \mu\text{s}$		-	-0.9	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	340	mW
			[1]	-	715	mW
		T _{sp} = 25 °C		-	2700	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drai	in diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	-230	mA
ESD maxim	um rating					
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	1000	V

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint. [2]

Measured between all pins. [3]





125 175 T_j (°C)

75

001aao122

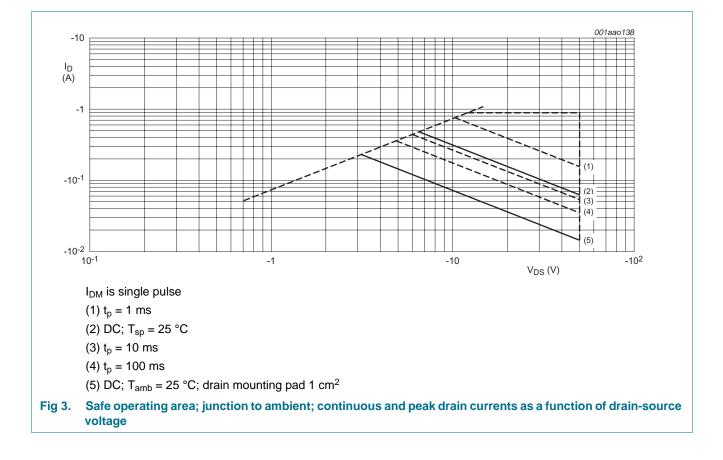
Product data sheet

BSS84AKM

3 of 16

BSS84AKM

50 V, 230 mA P-channel Trench MOSFET

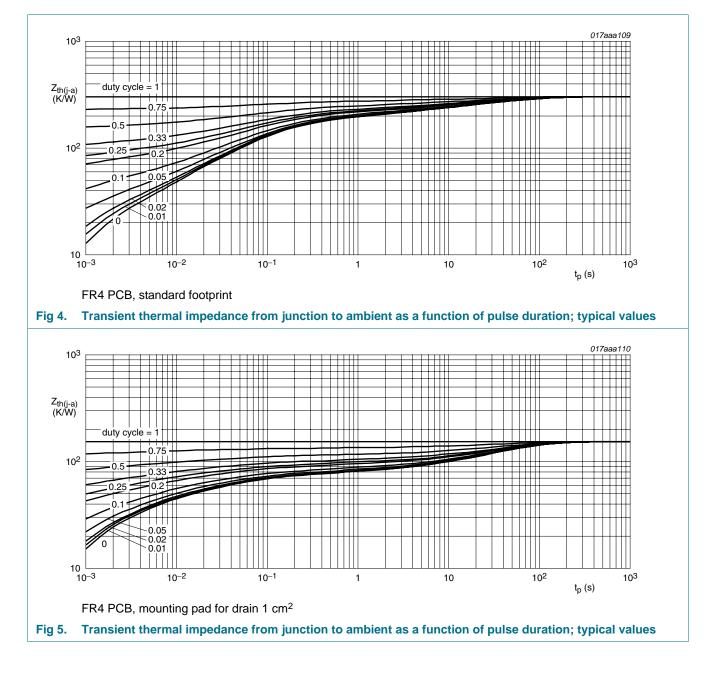


6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	310	360	K/W
			[2] _	150	175	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	40	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².



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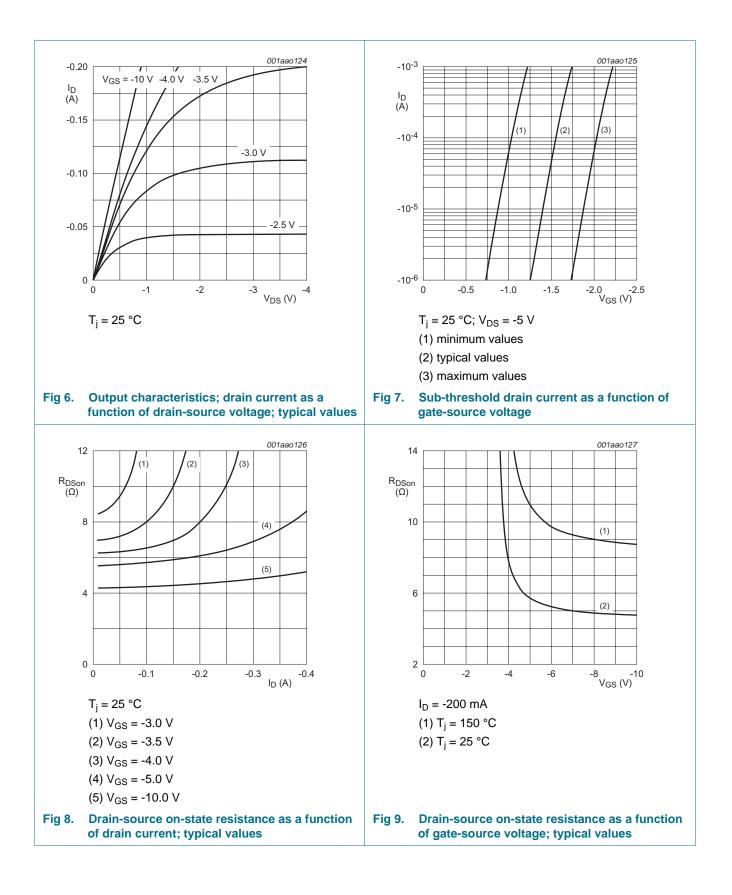
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7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = -10 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$	-50	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-1.1	-1.6	-2.1	V
I _{DSS}	drain leakage current	$V_{DS} = -50 \text{ V}; \text{ V}_{GS} = 0 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	-	-1	μΑ
		V_{DS} = -50 V; V_{GS} = 0 V; T_j = 150 °C	-	-	-2	μΑ
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-10	μΑ
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	-10	μΑ
R _{DSon}	drain-source on-state	V_{GS} = -10 V; I_{D} = -100 mA; T_{j} = 25 °C	-	4.5	7.5	Ω
re	resistance	V_{GS} = -10 V; I _D = -100 mA; T _j = 150 °C	-	8	13.5	Ω
		$V_{GS} = -5 \text{ V}; I_D = -100 \text{ mA}; T_j = 25 \text{ °C}$	-	5.7	8.5	Ω
9 _{fs}	forward transconductance	V_{DS} = -10 V; I_{D} = -100 mA; T_{j} = 25 °C	-	150	-	mS
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	V_{DS} = -25 V; I_D = -200 mA; V_{GS} = -5 V;	-	0.26	0.35	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.12	-	nC
Q_{GD}	gate-drain charge		-	0.09	-	nC
C _{iss}	input capacitance	V_{DS} = -25 V; f = 1 MHz; V_{GS} = 0 V;	-	24	36	pF
C _{oss}	output capacitance	T _j = 25 °C	-	4.5	-	pF
C _{rss}	reverse transfer capacitance		-	1.3	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -30 V; R_L = 250 Ω ; V_{GS} = -10 V;	-	13	26	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	11	-	ns
t _{d(off)}	turn-off delay time		-	48	96	ns
t _f	fall time		-	25	-	ns
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = -115 mA; V _{GS} = 0 V; T _i = 25 °C	-0.48	-0.85	-1.2	V

BSS84AKM

50 V, 230 mA P-channel Trench MOSFET

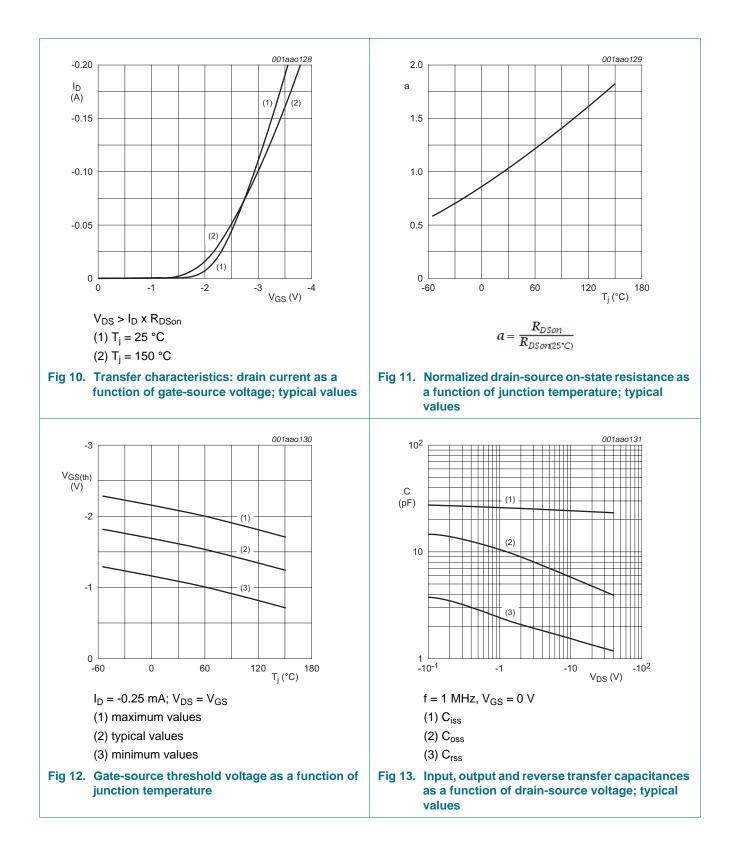


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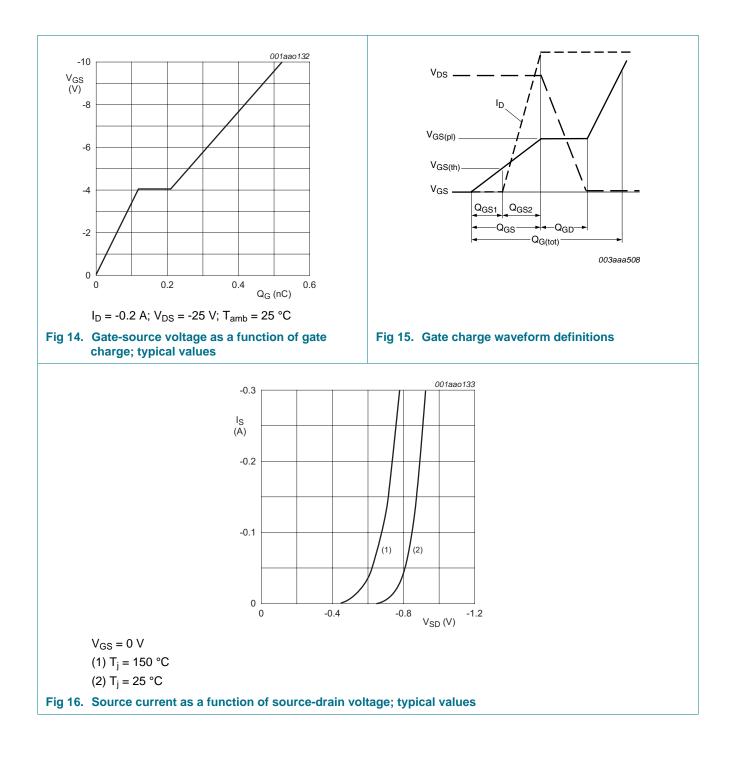


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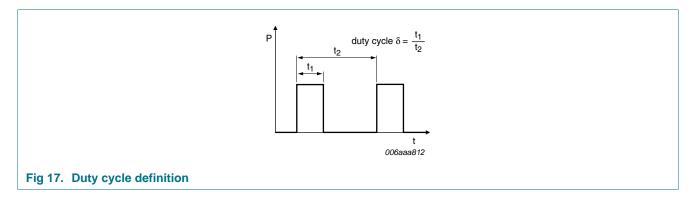
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50 V, 230 mA P-channel Trench MOSFET



50 V, 230 mA P-channel Trench MOSFET

8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

50 V, 230 mA P-channel Trench MOSFET

9. Package outline

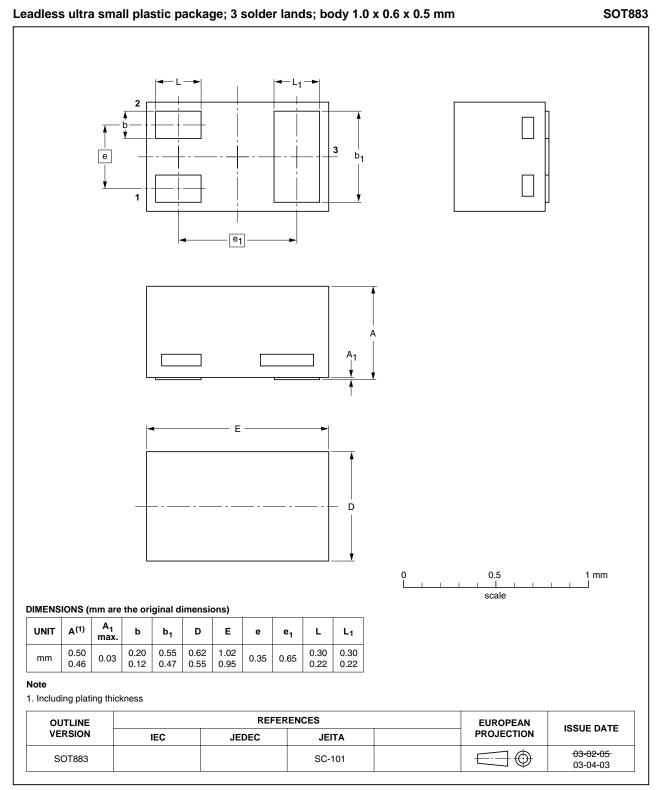
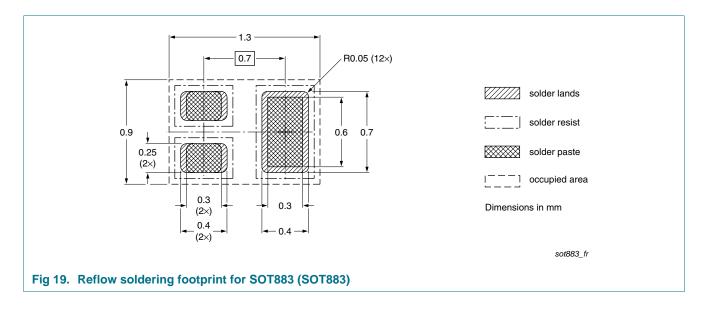


Fig 18. Package outline SOT883 (SOT883)

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10. Soldering



11. Revision history

Table 8.	Revision history					
Document	ID	Release date	Data sheet status	Change notice	Supersedes	
BSS84AKM	1 v.1	20110523	Product data sheet	-	-	

12. Legal information

12.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BSS84AKM

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50 V, 230 mA P-channel Trench MOSFET

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50 V, 230 mA P-channel Trench MOSFET

14. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Marking2
5	Limiting values
6	Thermal characteristics5
7	Characteristics6
8	Test information10
8.1	Quality information10
9	Package outline11
10	Soldering12
11	Revision history13
12	Legal information14
12.1	Data sheet status14
12.2	Definitions14
12.3	Disclaimers
12.4	Trademarks15
13	Contact information15

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